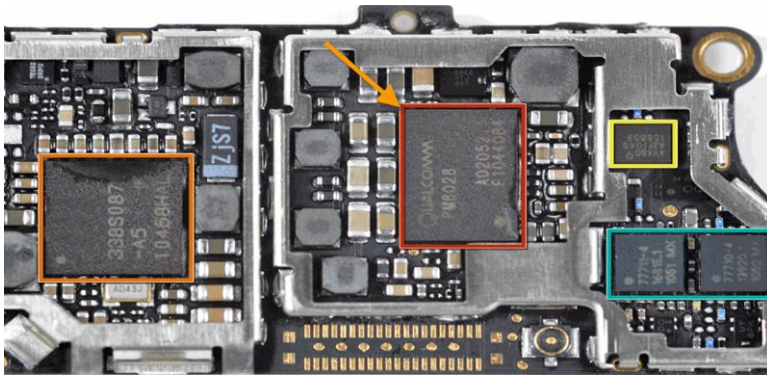


Silicon Valley  
Test Workshop



# Advanced Characterization Techniques for RF Components

Chris Ziomek  
GM, Design Test Solutions



Expand into Wireless Components & Design Test

## *Purpose Built Test Solutions*

- Providing the right tool for the job at hand
- Focus on providing solutions, not tool kits



Flexible Modular Instrumentation  
Perfect for Design Verification



Simple Robust Instrumentation  
Perfect for Volume Production

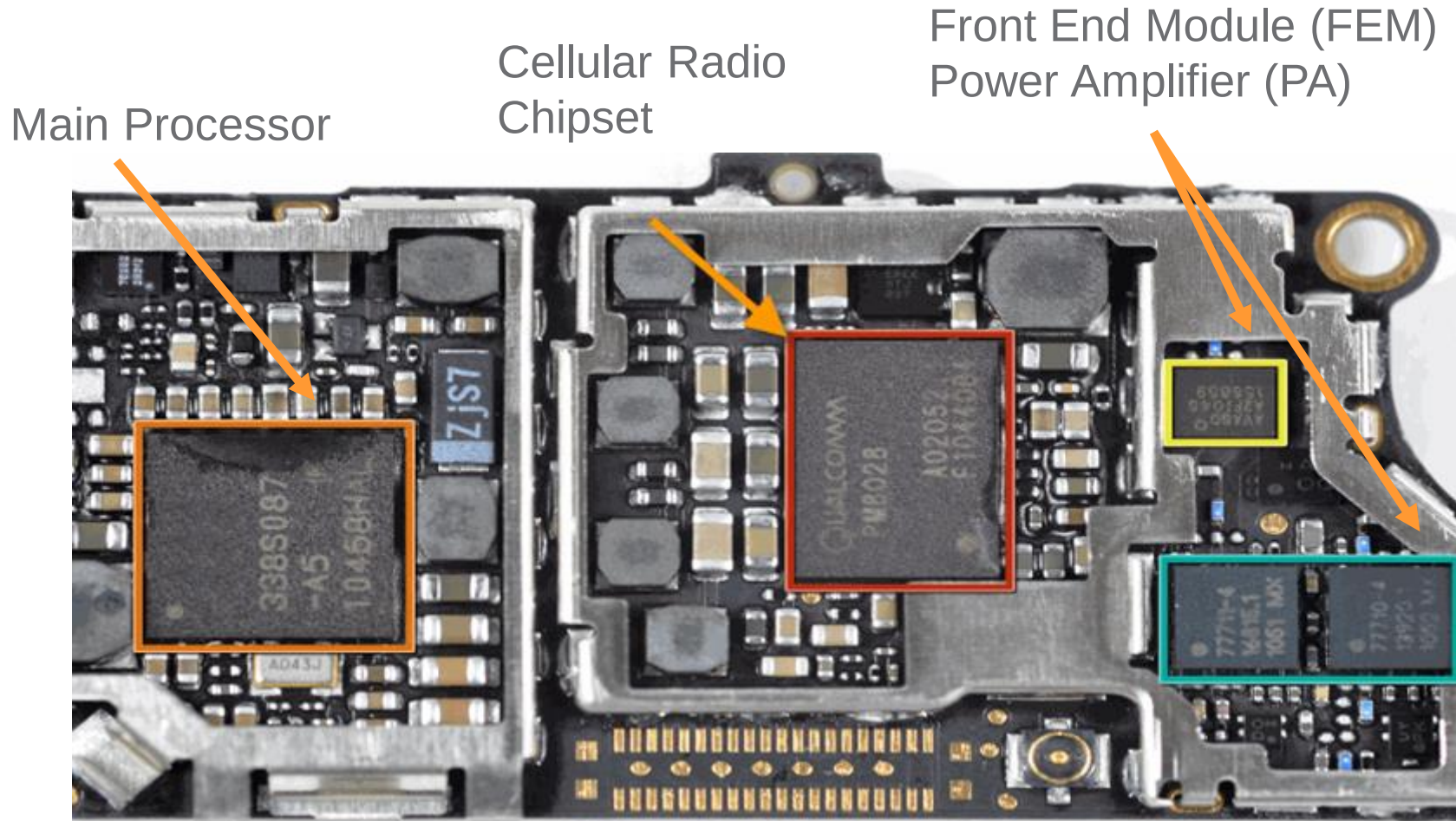
# *Outline*

- Mobile device design constraints
- Dynamic EVM
- Digital pre-distortion (DPD)
- Envelope tracking (ET)



# *Mobile Device Design Constraints*

# Mobile Device Design



Teardown of Mobile Phone

# Mobile Device Design Challenges

| Standard    | Peak-Average Ratio (dB) | Peak-Minimum Ratio (dB) | Max Bandwidth (MHz) |
|-------------|-------------------------|-------------------------|---------------------|
| GSM         | 0                       | 0                       | 0.2                 |
| EDGE        | 3.2                     | 17                      | 0.2                 |
| CDMA 2000   | 4-9                     | $\infty$                | 1.25                |
| LTE         | 8-12                    | $\infty$                | 20                  |
| 802.11a/b/g | 8-10                    | $\infty$                | 20                  |
| 802.11ac    | 8-14                    | $\infty$                | 160                 |

- More bandwidth (160MHz for 802.11ac, 100MHz for LTE-A)
- High-density modulations (256QAM for 802.11ac)
- Lower EVM contribution (e.g. 1.5% for 802.11ac 80MHz)
- Higher Peak-Avg. (PAR) → lower efficiency
- Infinite Peak-Min. → RF envelope drops to zero

# *Mobile Device Design Constraints*

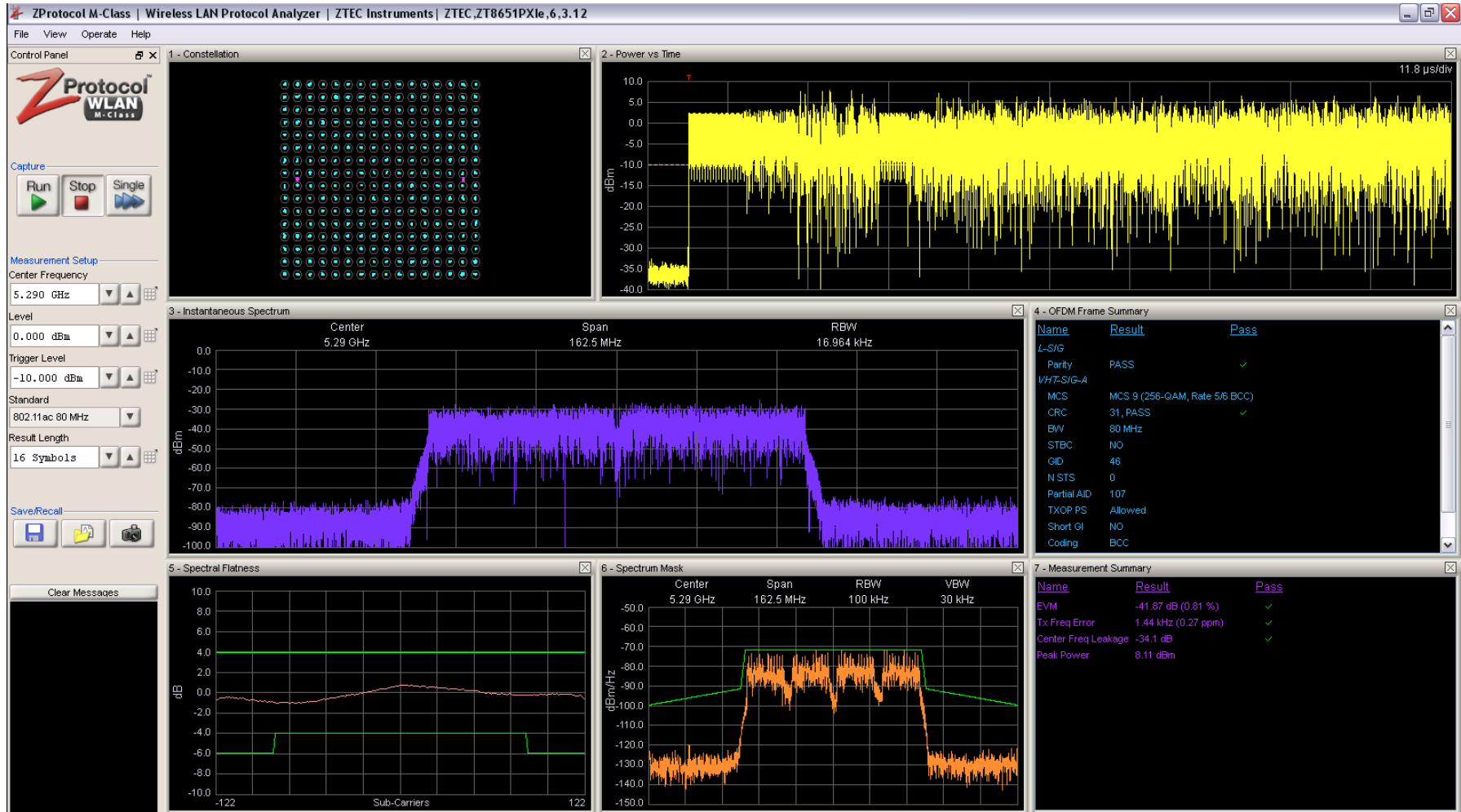
- Considerations driven by PA/FEM
  - Greater coverage area
  - Higher data rates
  - Longer battery life
- PA/FEM competing requirements
  - Higher RF power output
  - Higher Linearity
  - Higher Efficiency



## *Dynamic EVM*

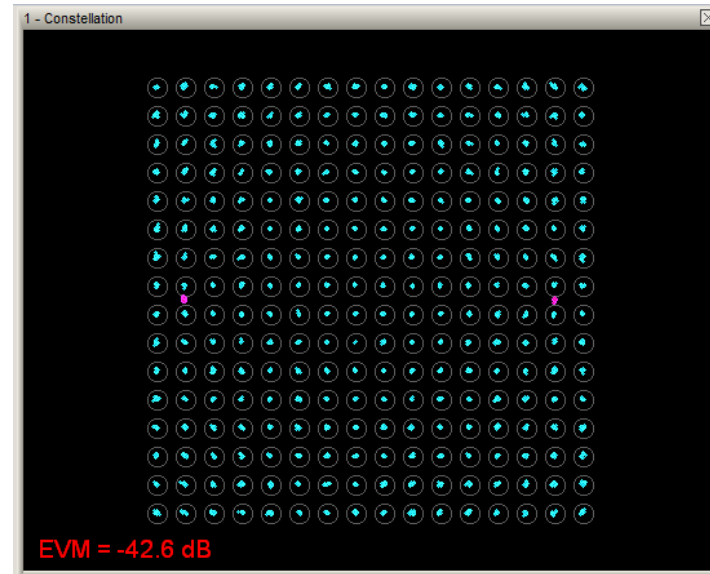
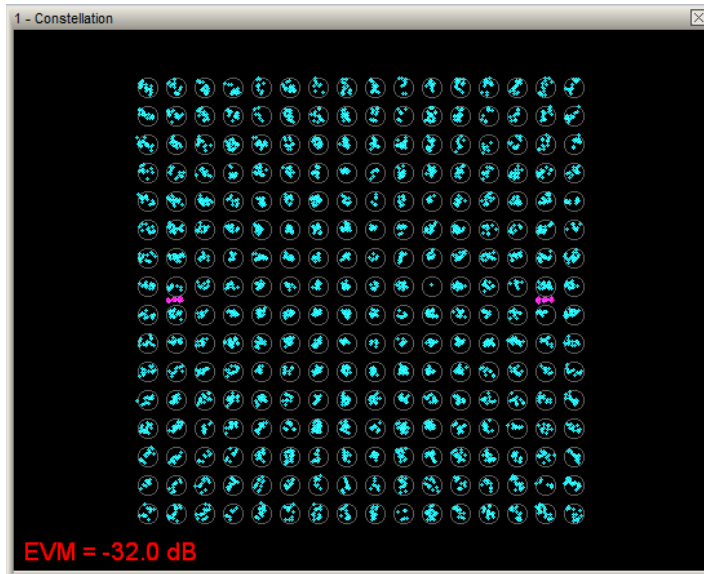


# Digital Radio Testing



# What is EVM?

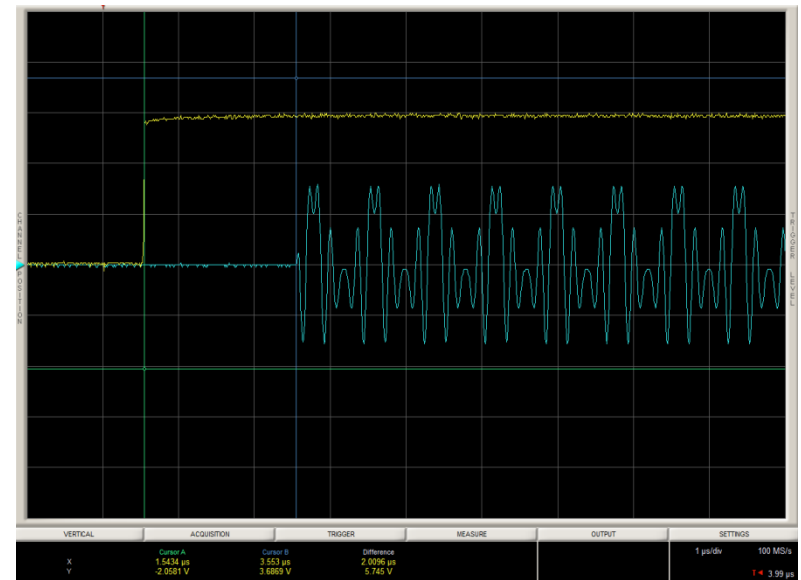
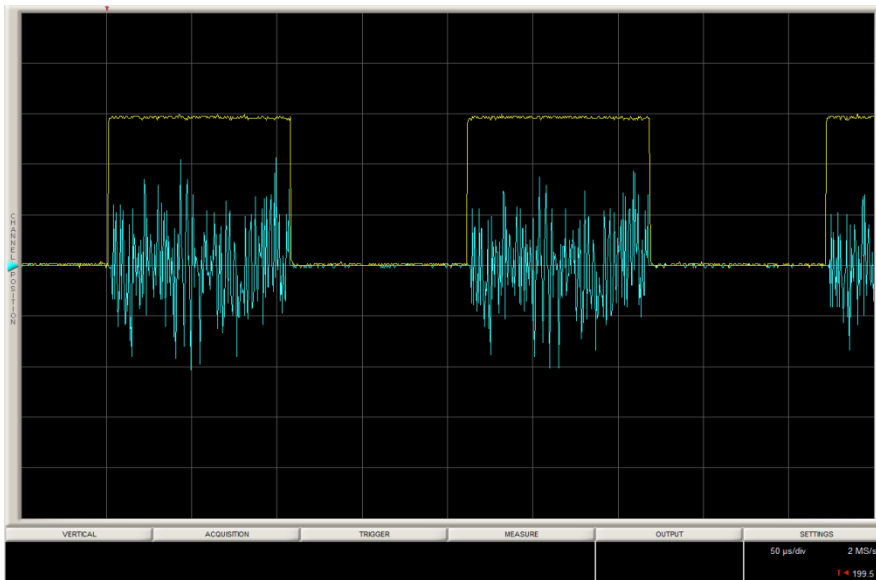
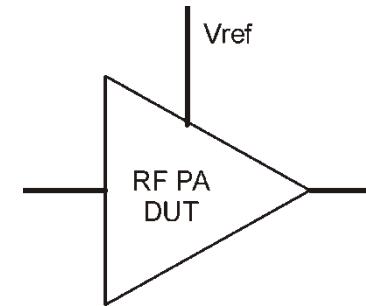
- Error Vector Magnitude
  - Rapid high coverage test technique
  - Comprehensive figure of merit for digital radio testing
  - First used by LitePoint in 802.11 WLAN production testing





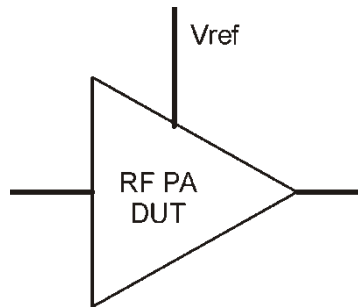
# Pulsed Radio Operation

- Conserve battery life
  - Digital radios used pulsed RF
  - Disable radio PA when not in use

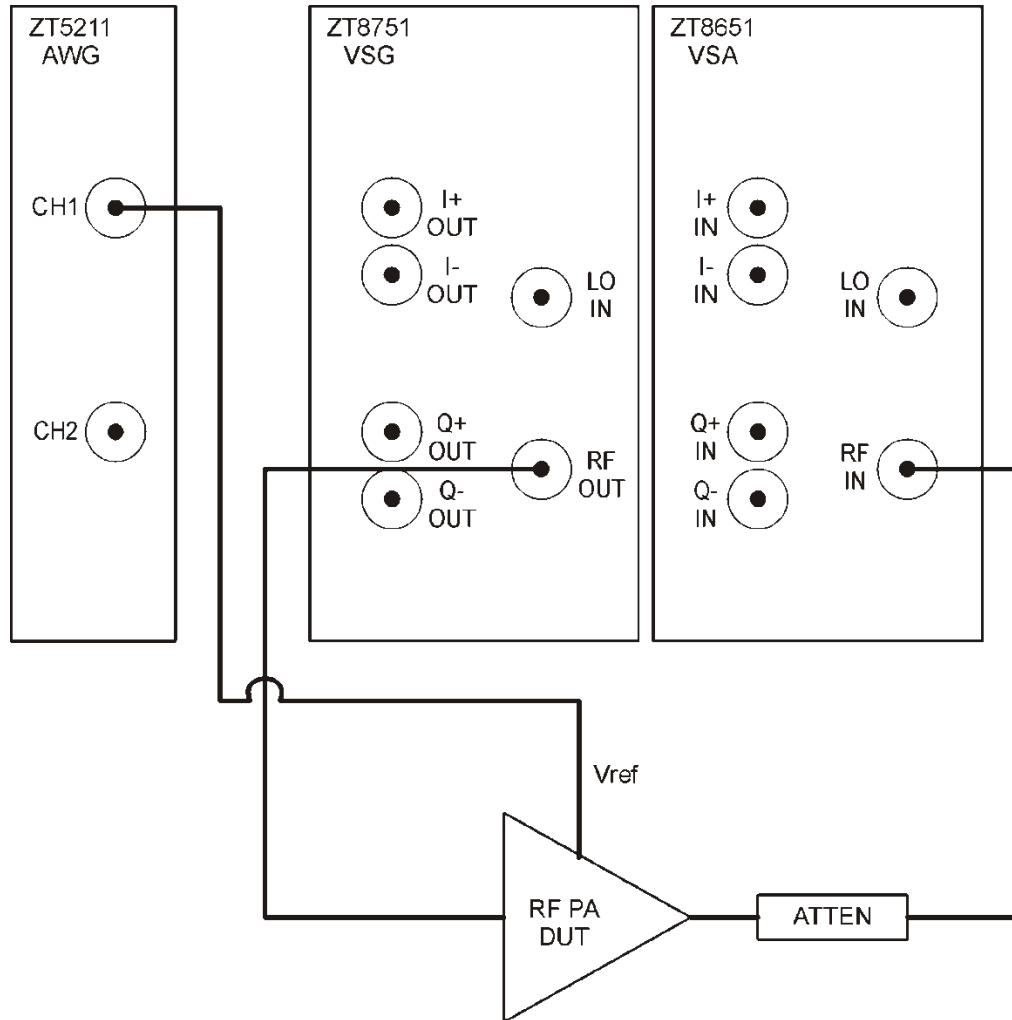


# *Pulsed Radio Operation*

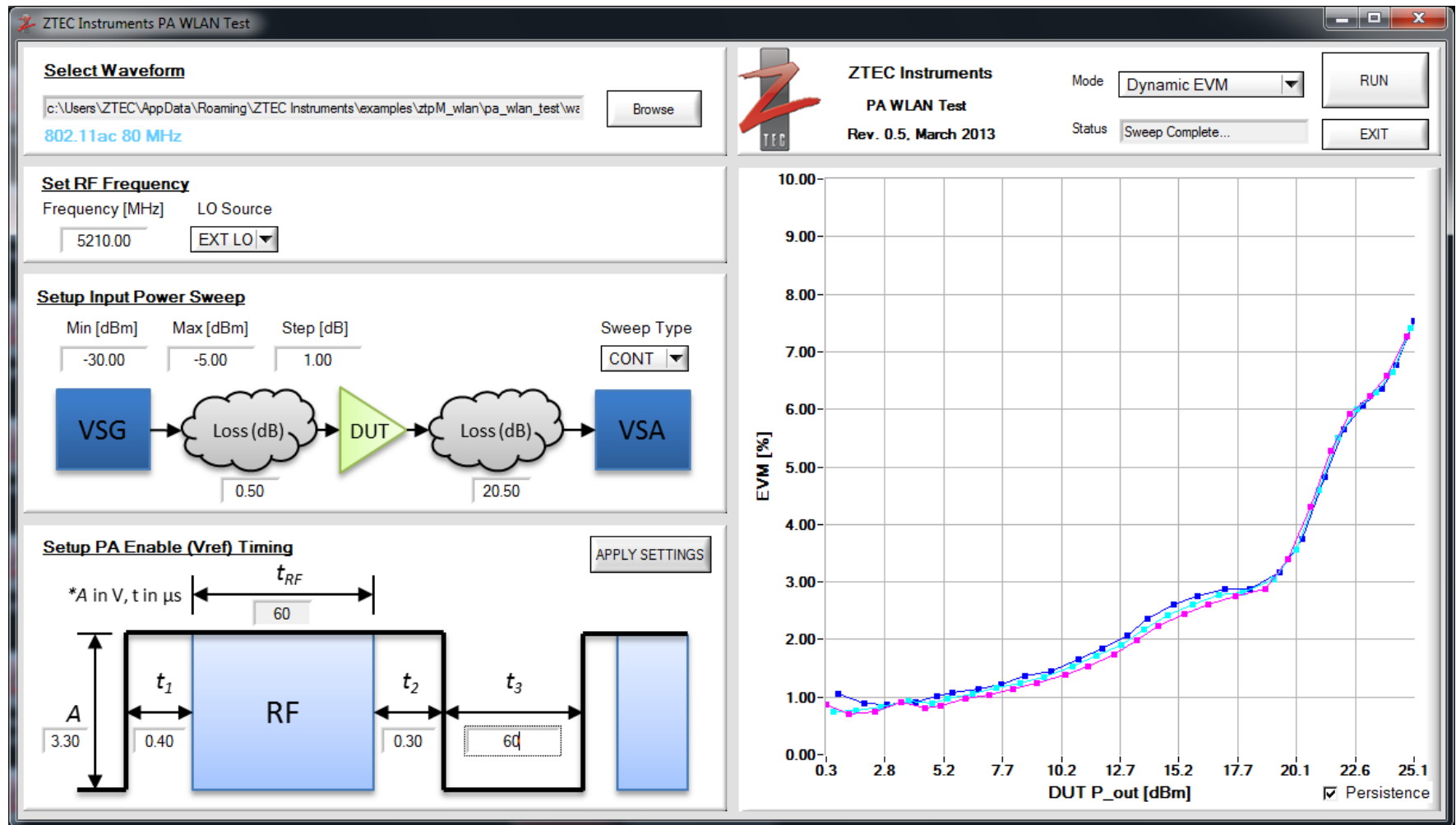
- System-level operation with pulsed RF & VREF
- Square wave applied to VREF
- Transient response distorts preamble
- Dynamic EVM shown to be worse than static EVM
  - S. Yoon, Marvell, IEEE-MTT 2007
  - mobile device production failures: dynamic EVM is now required!



# Dynamic EVM Testing



# Dynamic EVM Testing



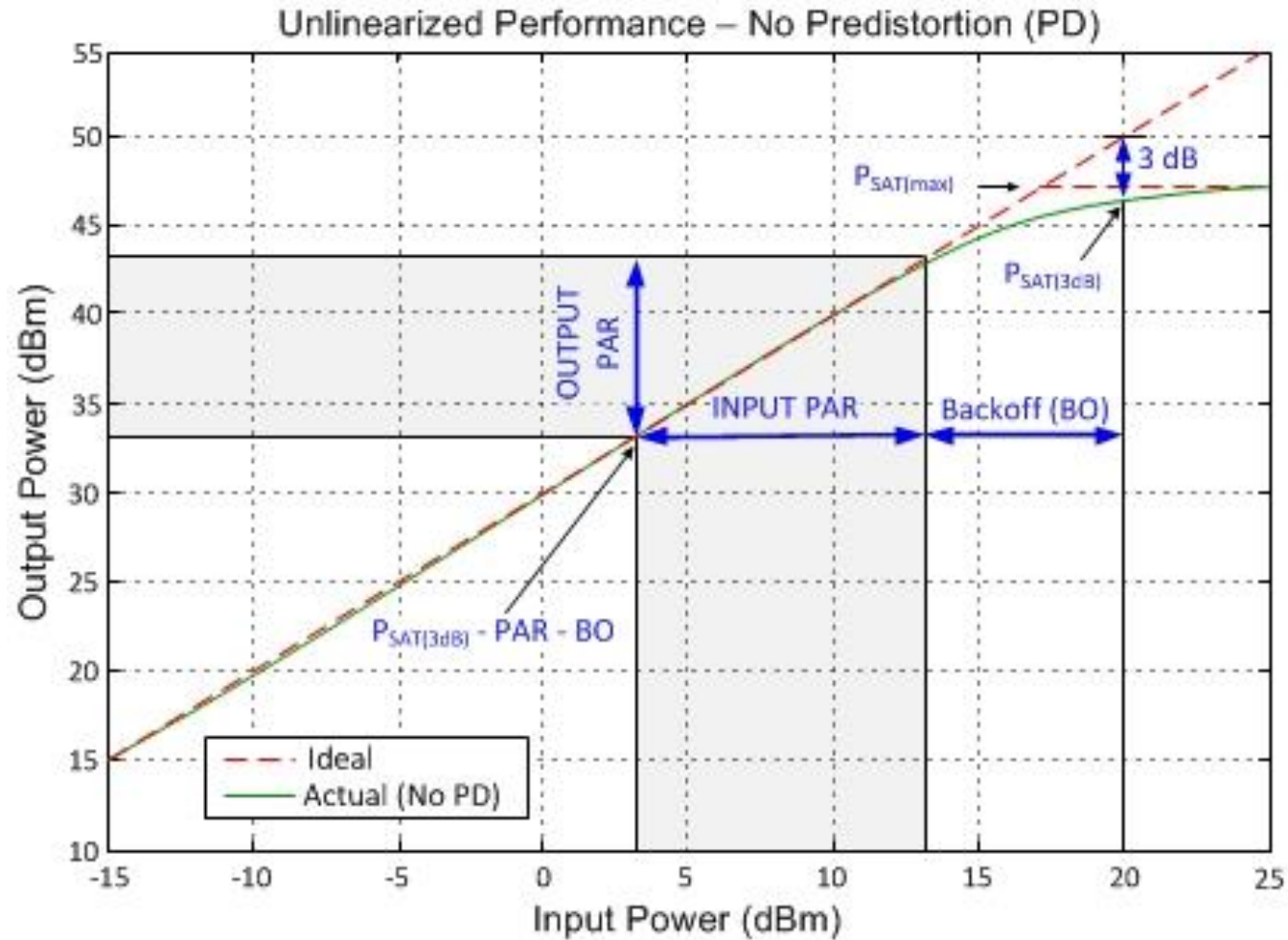
Dynamic EVM vs. Static EVM - Duty Cycles: 5%, 50%, 100%



# *Digital Pre-Distortion (DPD)*



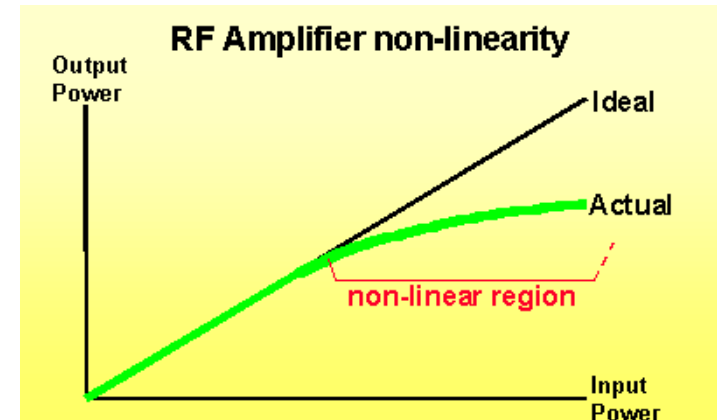
# PA Linearity



# PA Linearity

- Linearity measures

- Spectral Mask
- Adjacent Channel Power Ratio (ACPR)
- Third Order Intercept Point (IP3)
- 1 dB compression point
- AM-to-AM, AM-to-PM distortion

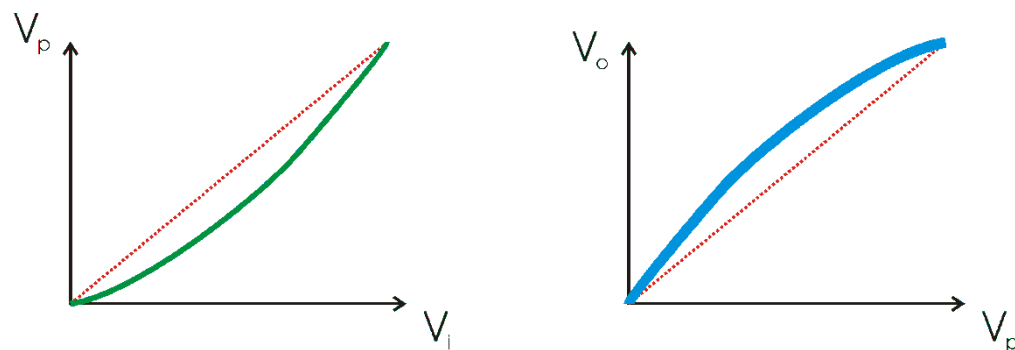
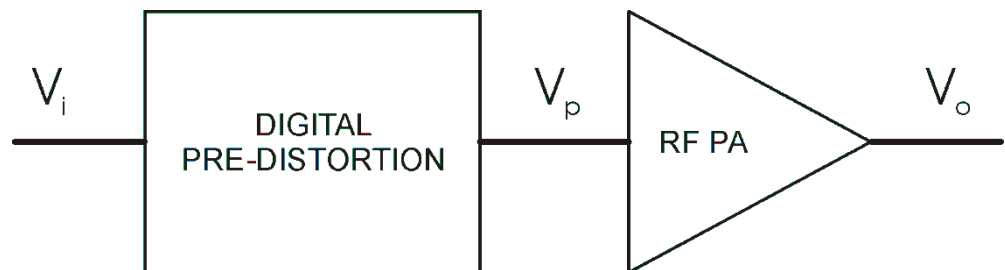


- Strategies for handling high PAR

- Back off – operate PA in linear region (inefficient)
- Crest factor reduction – limit peaks before reaching PA
- Pre-distortion – compensate for PA nonlinearity

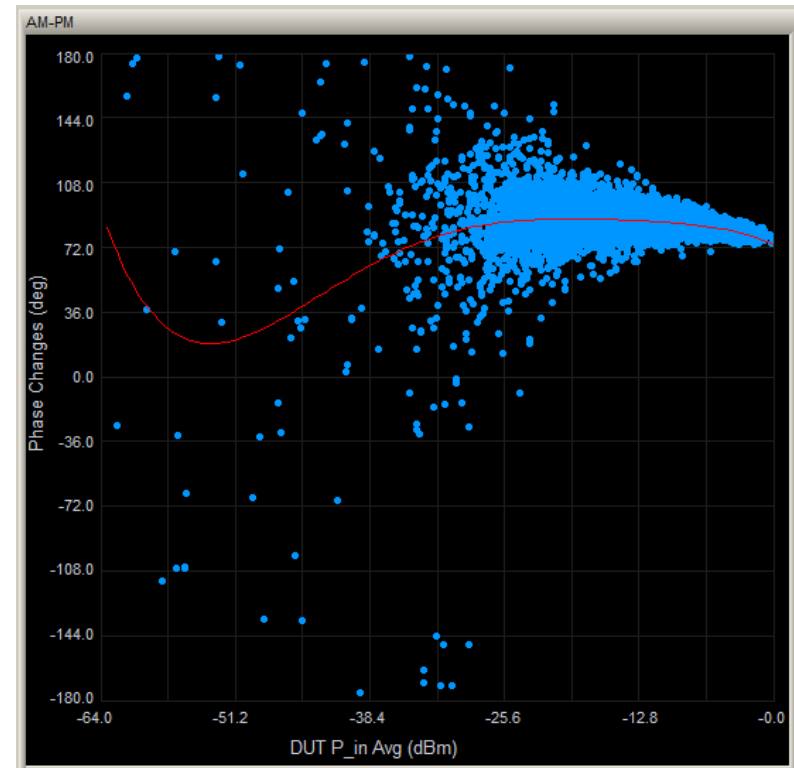
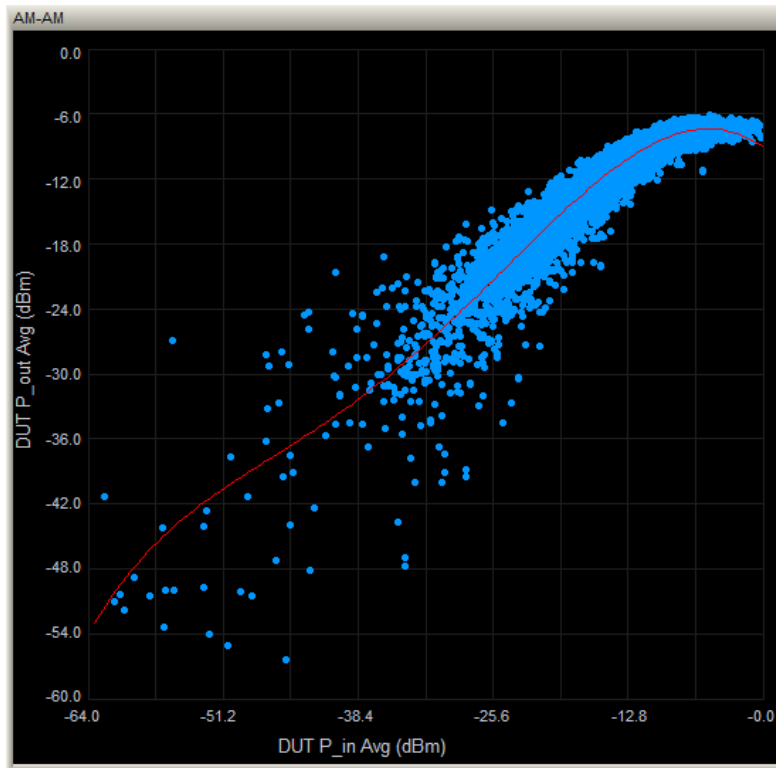
# Digital Pre-Distortion (DPD)

- Latest chipsets support DPD
  - Use an inverse operation to linearize PA
  - Compensate for AM-to-AM and AM-to-PM distortion
  - Algorithms
    - Look-up tables (LUT)
    - Memory Polynomial

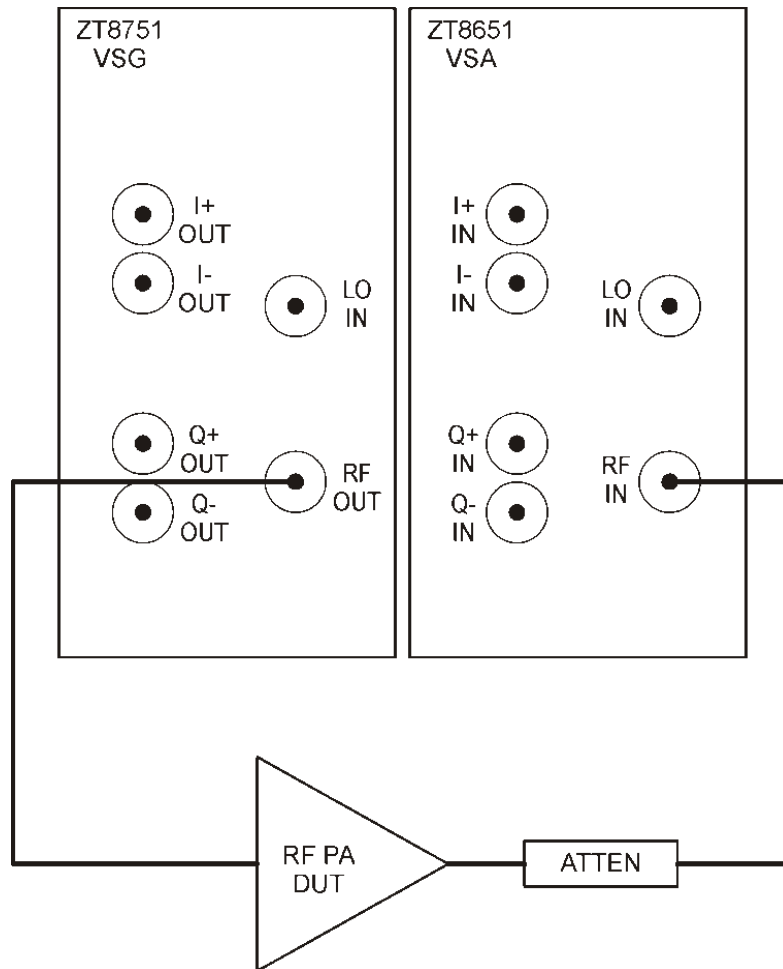


# Digital Pre-Distortion (DPD)

- PA memory
  - Transient behavior exposed by high PAR
  - More memory  $\rightarrow$  more spread in distribution



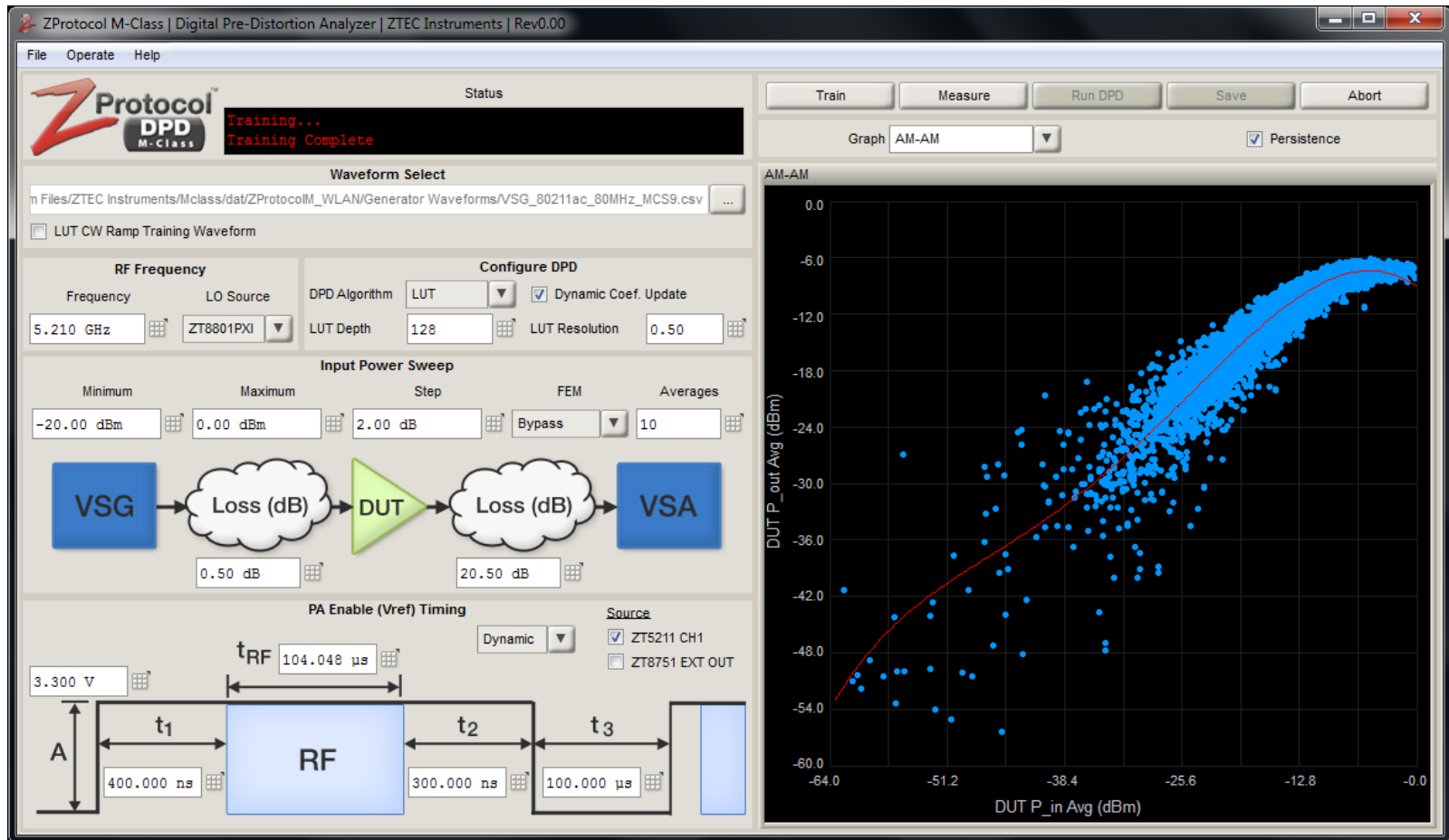
# DPD Testing



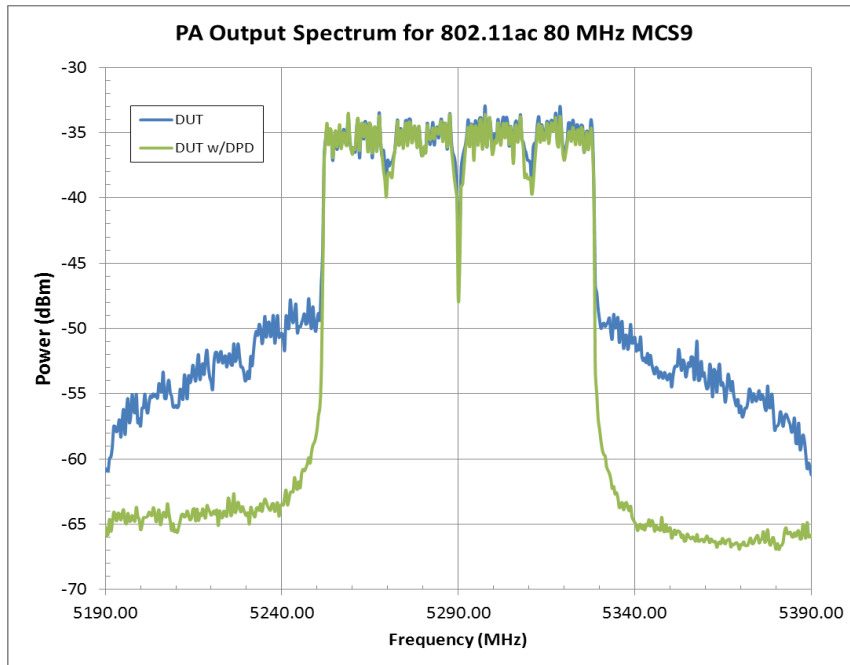
## Test sequence

- Training
- Calculate DPD coefficients
- Create DPD waveform

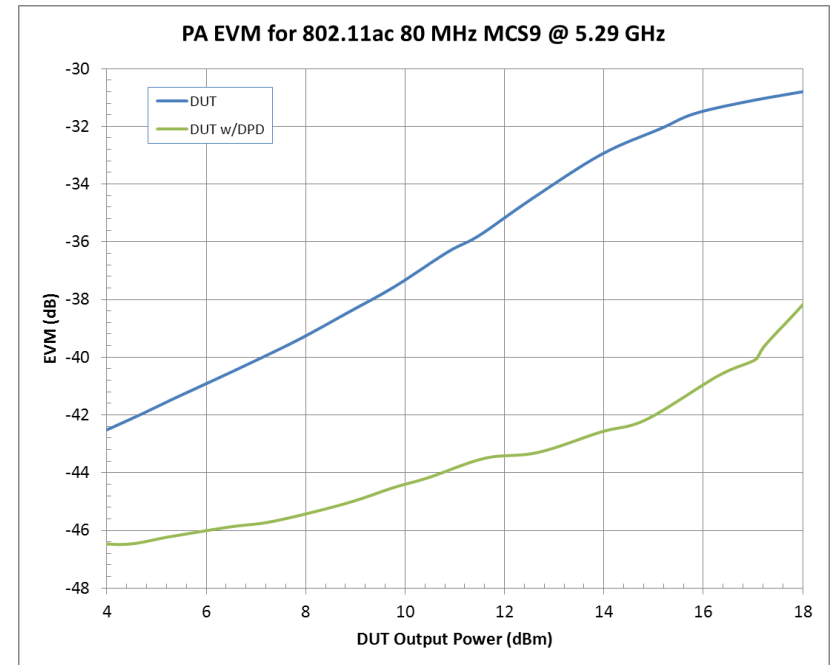
# DPD Testing



# DPD Improvements

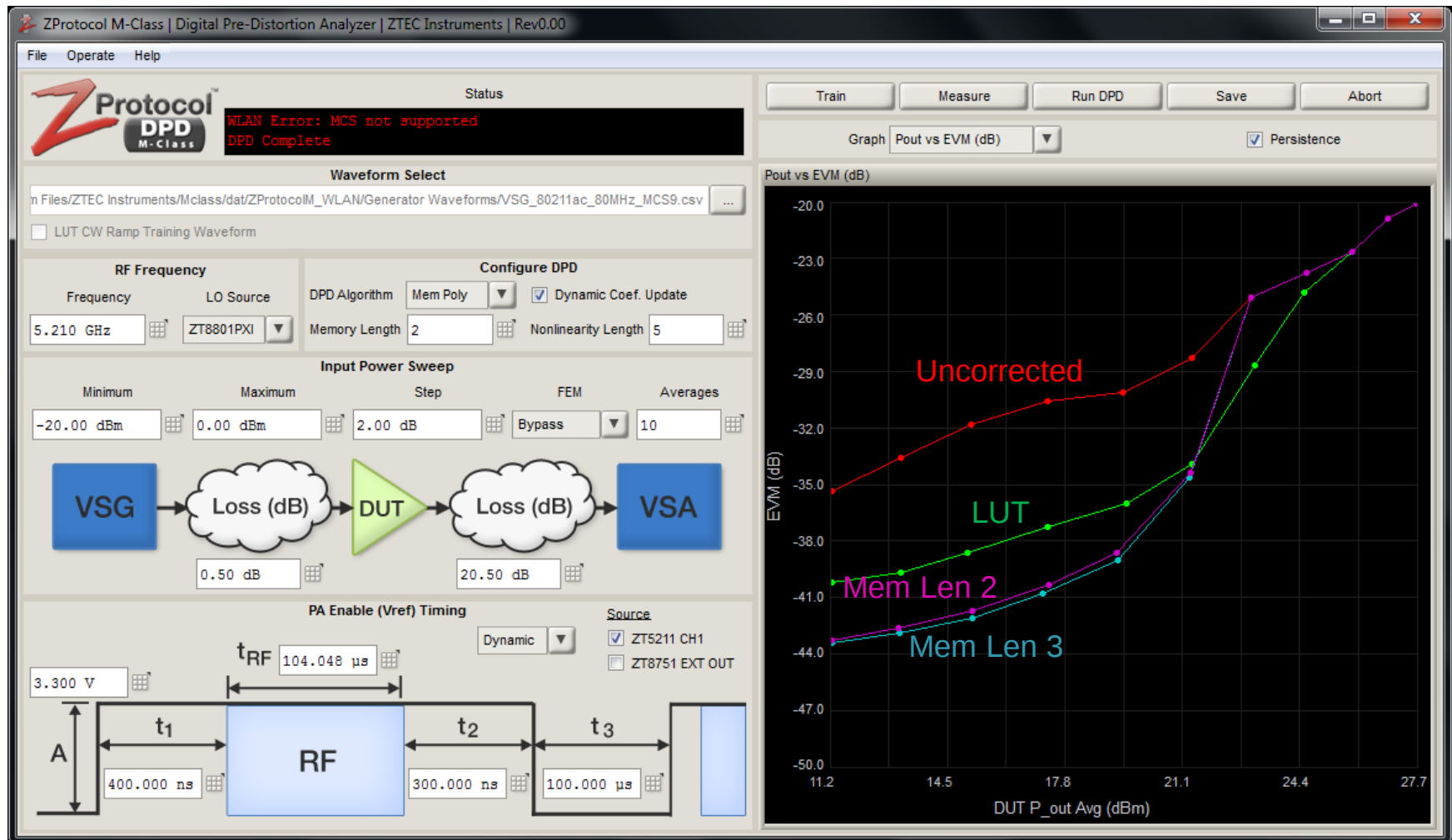


Spectral Mask Improvements



EVM Improvements

# DPD Algorithms





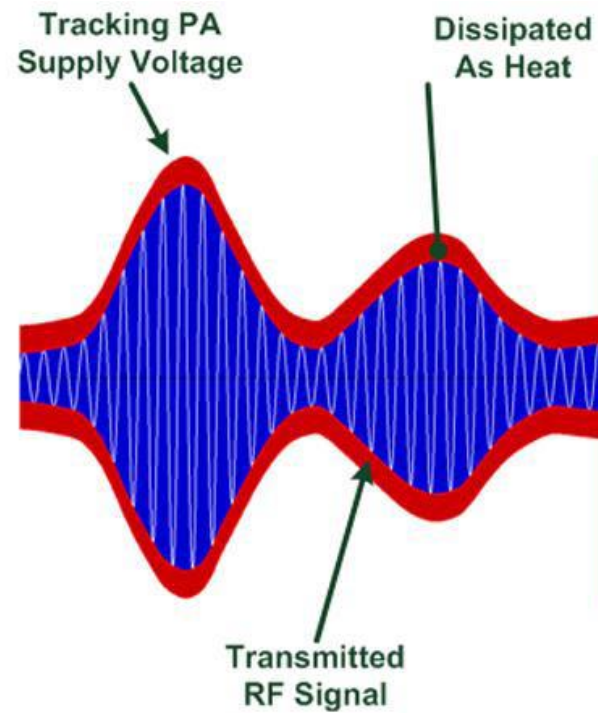
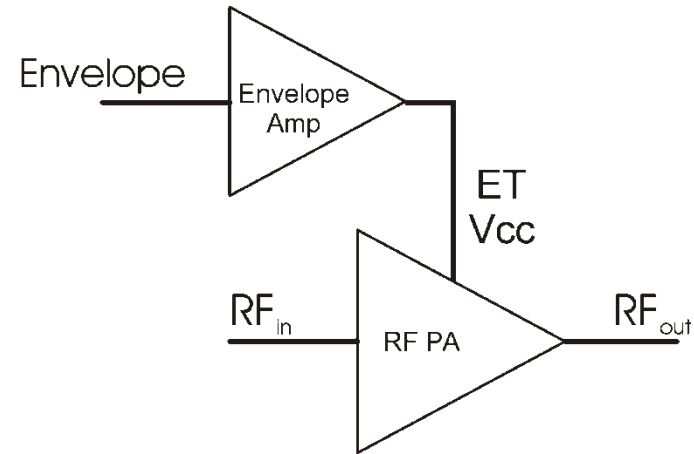
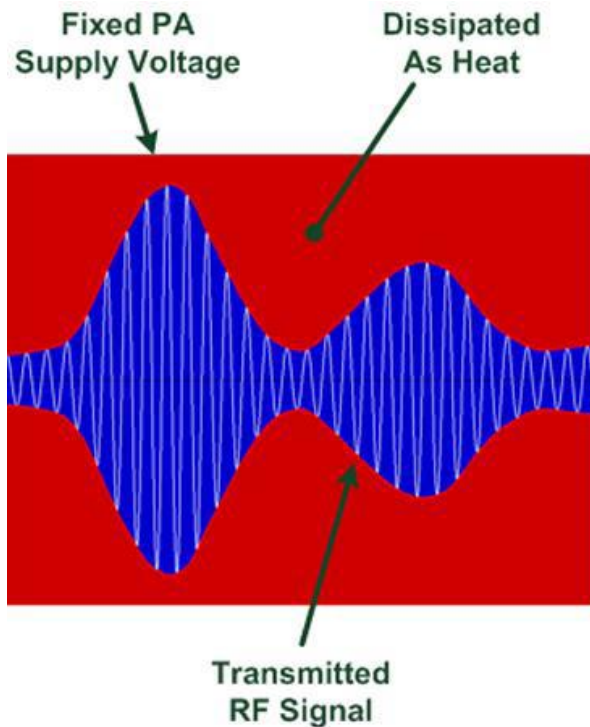
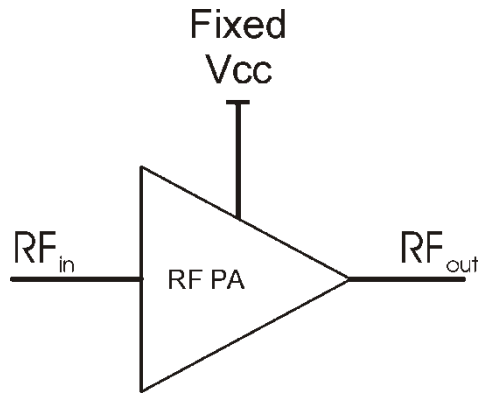
## *Envelope Tracking (ET)*



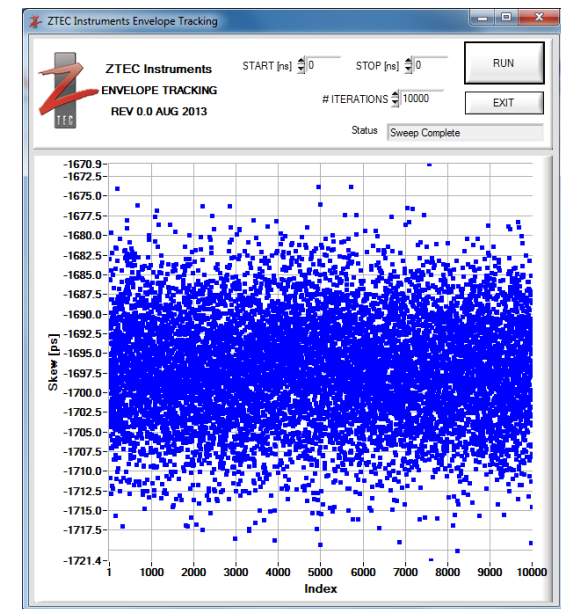
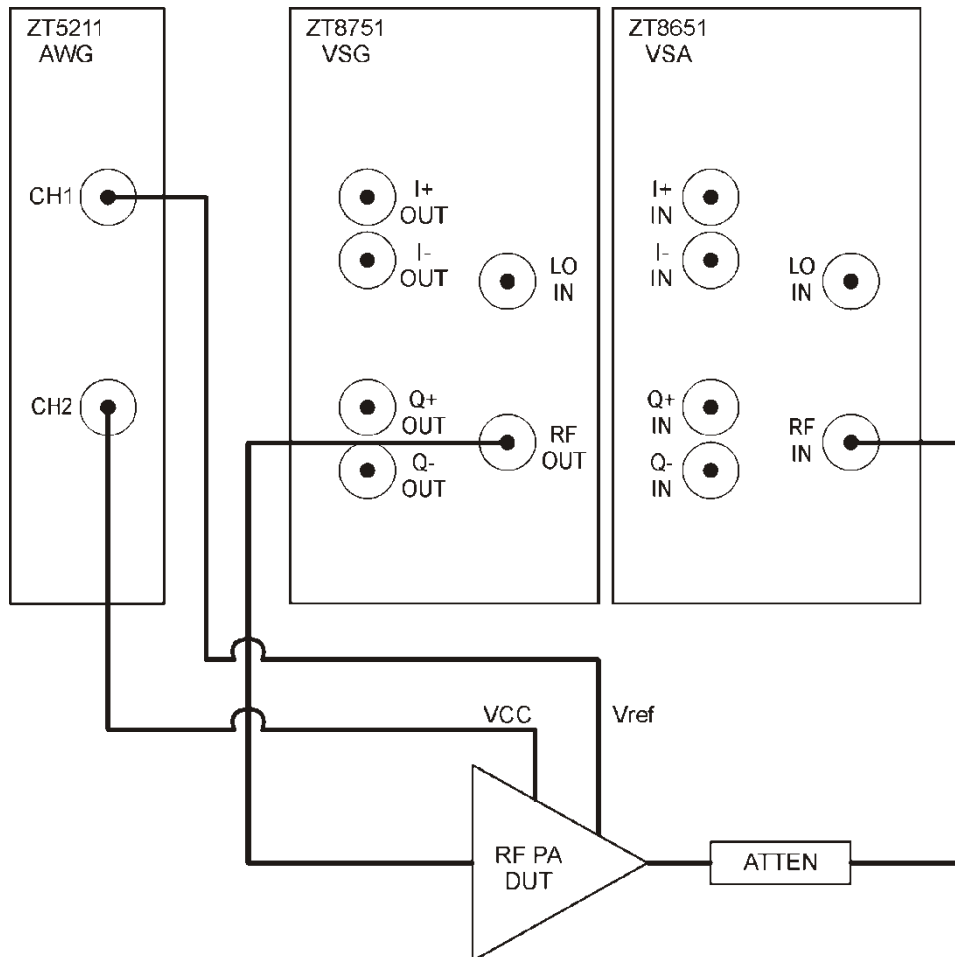
# PA Efficiency

- Higher PAR → greater back-off → lower efficiency
- Power Added Efficiency (PAE)
  - DC → RF efficiency
  - $PAE = \frac{P_{out} - P_{in}}{P_{DC}} \times 100\%$
  - Example: PA class AB
    - Fixed Vcc → 20% PAE
    - ET Vcc → 30-35% PAE
- Envelope Tracking (ET) improves system efficiency
  - Maintains PA in constant-compression

# Envelope Tracking (ET)

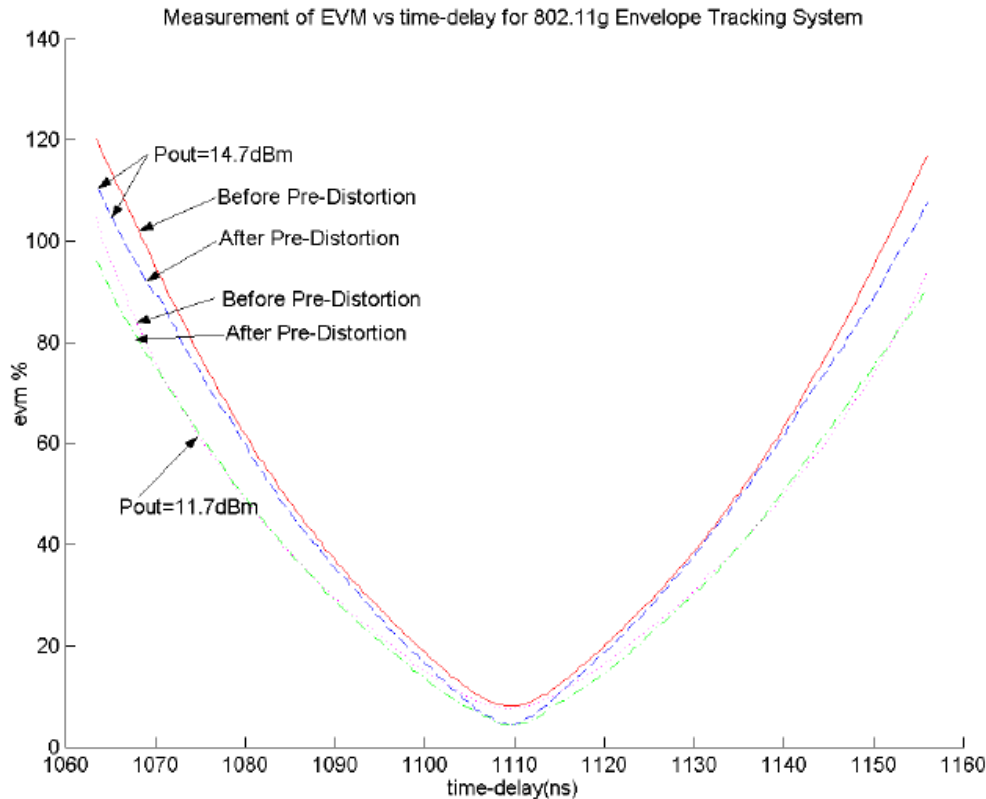


# ET Testing

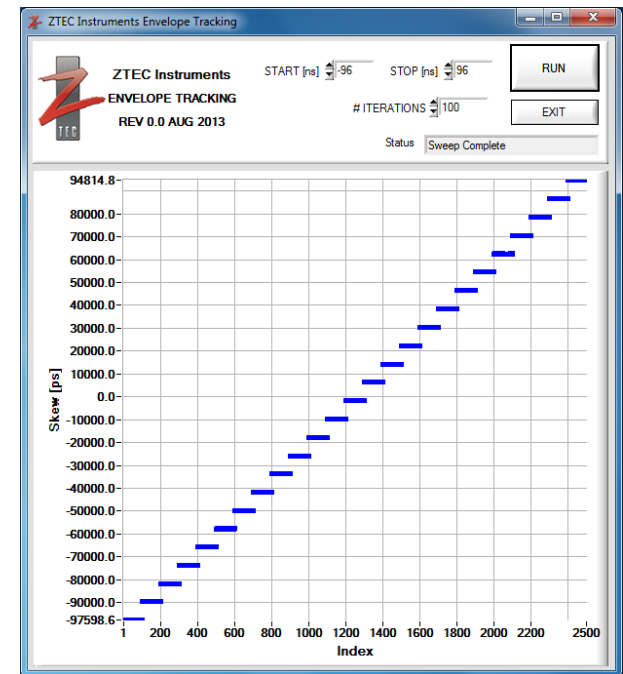


RF-to-Envelope Jitter:  
50 ps peak-to-peak  
6.6ps std. dev.

# ET Testing



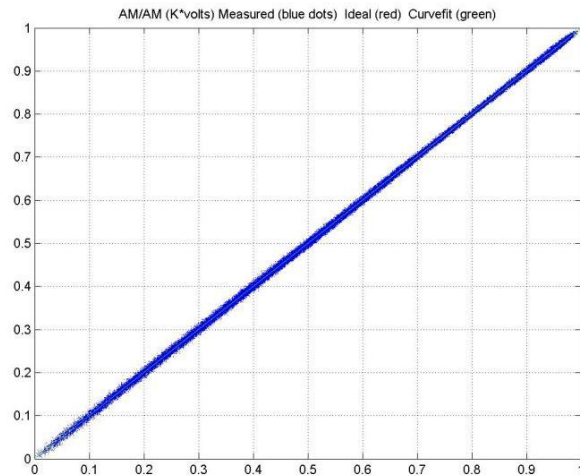
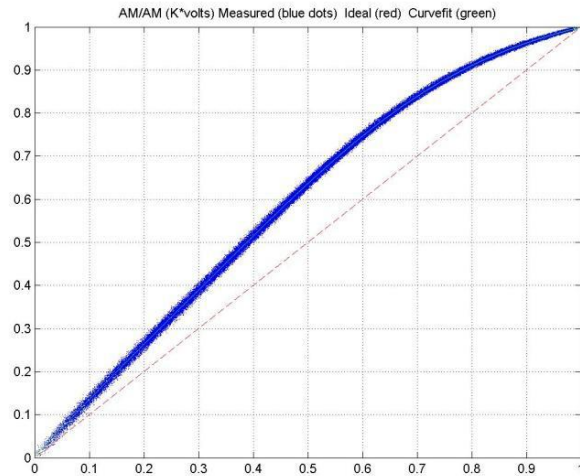
Graph courtesy of P. Draxler,  
Qualcomm, IEEE-IMS 2013



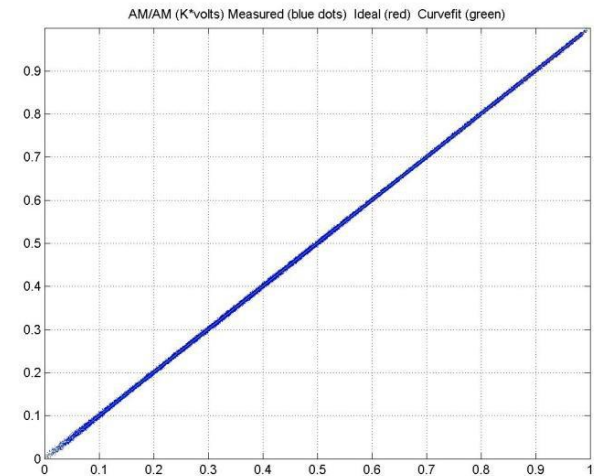
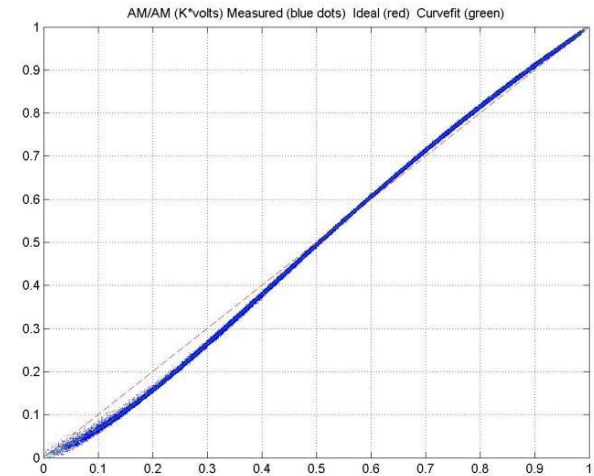
RF-to-Envelope Stepping  
-96ns to +96ns  
8ns steps

# ET + DPD

## Fixed Vcc



## ET Vcc



Before  
DPD

After  
DPD

## *Conclusions*

- There is a significant amount of cutting-edge technology in today's mobile devices
- PA/FEM selection drives significant design considerations for wireless coverage, max data rate, and battery life
- Advanced PA/FEM characterization is made possible with the latest generation of modular RF test equipment

## Q&A

- Thank You!
- Questions?
- Come see us at Booth #4
  - Wireless Test Set Demo
  - Supplemental Application Note
- Contact Information
  - Chris Ziomek, [chris.ziomek@litepoint.com](mailto:chris.ziomek@litepoint.com)